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Preliminary Call for Papers

About the conference:

SPLC, the premier forum where practitioners, researchers, and educators can present and discuss the most recent ideas, innovations, trends, experiences, and concerns in the area of software product lines and software product family engineering invites you to come to Munich.

We invite a range of topics related to software product line engineering, both traditional and modern. These topics include, but are not limited to:

- Industrial experiences in product line engineering
- Techniques and tools for product line engineering
- Evolution and life-cycle issues of product line assets
- Business issues for product lines
- Organizational and process issues for product lines
- Empirical studies in product line engineering

We invite the following classes of original, unpublished submissions:

(1) RESEARCH PAPERS (max. 10 pages) describe original research contributions (theoretical, conceptual) to the field of software product line engineering. A research paper should clearly describe the problem that has been tackled, the state of the art with respect to the problem, the solution that is suggested and the potential -- or even better the evaluated -- benefits of the contribution.

We also call for short research papers (max. 5 pages), which are intended to report ideas in their early stages, and are not required to show complete/evaluated results.

(2) INDUSTRIAL PAPERS (max. 10 pages for full, 5 for short papers) describe experience in introducing, implementing, and evolving product lines and success stories or problem reports of applications of product line engineering methods, techniques, and tools in industry. We explicitly solicit papers written from the perspective of applying PLE in real-world industrial settings, showing industrial relevance, lessons learned, and a thorough evaluation of the results.

Submissions should follow the IEEE conference format and will be reviewed by at least three members of the SPLC 2011 program committee. We invite you to be part of SPLC.

Important Dates:

The following dates are important for technical and industry papers:

- Submission deadline: Feb. 14, 2011
- Notification: Apr. 15, 2011
- Camera ready: May 9, 2011

Publication:

It is intended to have all accepted papers published by IEEE CPS and make them available online at the CSDL and Xplore digital libraries. For more information about the conference, please visit the conference page at

<http://www.splc2011.net>.

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